SPECIFICATIONS				
CUSTOMER	: _			
SAMPLE CODE	: : _	SH280142T001-ZBR		
MASS PRODUCTION CODE	: _	PH280142T001-ZBR		
SAMPLE VERSION	•	01		
SPECIFICATIONS EDITION	:	003		
DRAWING NO. (Ver.)	:	LMD-PH280142T001-ZBR (Ver.002)		
PACKAGING NO. (Ver.)		PKG-PH280142T001-ZBR (Ver.00&)		

Customer Approved

Checked

張慶源

Yuan Chang

Designer 陳宗淇

Howard Chen

Date:

2025.02.04 TWRD APR

- ☐ Preliminary specification for design input
- Specification for sample approval

Approved

廖志豪

Rex Liao

POWERTIP TECH. CORP.

Headquarters: No.8, 6th Road, Taichung Industrial Park,

Taichung, Taiwan

台中市 407 工業區六路 8號

TEL: 886-4-2355-8168

FAX: 886-4-2355-8166

E-mail: sales@powertip.com.tw

Http://www.powertip.com.tw



History of Version

Date (mm / dd / yyyy)	<u>Ver.</u>	Edi.	<u>Description</u>	<u>Page</u>	Design by
08/22/2023	01	001	Preliminary.	-	Howard
11/12/2023	01	002	Frist Sample Modify driver IC,from OTA7290N to ST7703I Modify Absolute Maximum Ratings Modify DC Electrical Characteristics Modify Optical Characteristics Modify Block Diagram Modify Timing Characteristics Modify Drawing	- 4 5 6 11 14~17 Appendix	Howard
02/03/2025	01	003	Modify Operating Temperature to -30~80℃	5,10	Howard



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics
- 1.7 Touch Panel Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix:

1.LCM Drawing

2.LCM Packaging Specifications



1. SPECIFICATIONS

1.1 Features

<u>Item</u>	Standard Value
Display Type	280 * 3 (RGB) * 1424 Dots
LCD Type	Full Viewing Angle , Normally Black , Transmissive type
Screen size(inch)	7.0 inch
Color configuration	RGB-Strip
Backlight Type	LED B/L
Weight	77.5g
Interface	4-Lanes MIPI Interface
Other(controller/driver IC)	Sitronix—ST7703I (Or Compatible IC)
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news_detail.php?Key=1&clD=1

1.2 Mechanical Specifications

<u>ltem</u>	<u>Standard Value</u>	<u>Unit</u>
Outline Dimension	43.3(W) * 201.0(L) * 5.17(H)	mm

LCD panel

<u>Item</u>	Standard Value	<u>Unit</u>
Active Area	33.6(W) * 170.88 (L)	mm
Pixel Size	0.12(W) * 0.12(H)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

<u>ltem</u>	<u>Symbol</u>	Condition	Min.	Max.	<u>Unit</u>	Remark
Power Supply for TFT Panel	VCC	GND=0V	-0.3	6.6	V	
Operating Temperature	Top	Note 1	-30	+80	°C	-
Storage Temperature	Tst	Note 2	-30	+80	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any time. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 1: Ts is the temperature of panel's surface

Note 2: Ta is the ambient temperature of samples

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = $25^{\circ}C$

<u>ltem</u>	Symbol	<u>Condition</u>	Min.	Typ.	Max.	<u>Unit</u>
Power Supply	VCC	GND=0V	2.5	2.8	3.3	V
Input Voltage	ViH	GND=0V	0.7VCC	-	VCC	V
Input Voltage	VIL	GND=0V	GND	-	0.3VCC	V
Output H/L Level	VOH	GND=0V	0.8VCC	-	VCC	V
Voltage	VOL	GND=0V	GND	-	0.2VCC	V
Supply Current	ICC	VCC= 2.8 V Pattern=PHOTO	-	60	90	mA



1.5 Optical Characteristics

TFT LCD Module

VCC= 2.8 V, Ta=25°C

<u>ltem</u>	<u>s</u>	<u>ymbol</u>	<u>Condition</u>	Min.	Typ.	Max.	unit	
Response time		Tr+Tf	Ta = 25°C θX, θY = 0°	-	4	35	ms	Note 2
	Тор	θΥ+		80	85	1		
Viewing angle	Bottom	θΥ-	CR ≥ 10	80	85	-	Deg.	Note 4
viewing angle	Left	θΧ-	CIV Z 10	80	85	-	Deg.	NOIE 4
	Right	θΧ+		80	85	-		
Contrast ratio		CR		500	600	-	-	Note 3
	White	Χ		0.24	0.29	0.34		
	vviile	Υ		0.30	0.35	0.40		
Color of CIE	Red	X	Ta = 25°C	0.57	0.62	0.67		
Coordinate	Neu	Υ	$\theta X, \theta Y = 0^{\circ}$	0.30	0.35	0.40		Note1
(With B/L & T/P)	Green	Х	0, 01 - 0	0.25	0.30	0.35	-	Note
(With D/L & 1/1)	Green	Y		0.59	0.64	0.69		
	Blue	X		0.07	0.12	0.17		
	Diue	Υ		0.05	0.10	0.15		
Average Brightness Pattern=white display		IV	IF= 80mA	350	400	-	cd/m2	Note1
(With B/L & T/P)*1 Uniformity (With B/L & T/P)*2		△ B	IF=80mA	70	-	-	%	Note1



Note 1:

*1: △B=B(min) / B(max) * 100%

*2: Measurement Condition for Optical Characteristics:

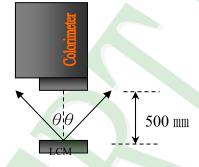
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency

b: Measurement Distance: 500 ± 50 mm, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





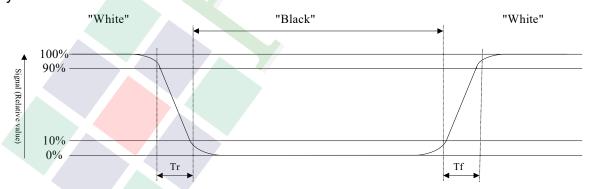
Colorimeter=BM-7 fast

To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note 2: Definition of response time:

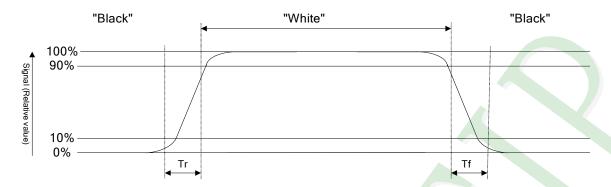
The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes. Refer to figure as below:

Normally White





Normally Black



Note 3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

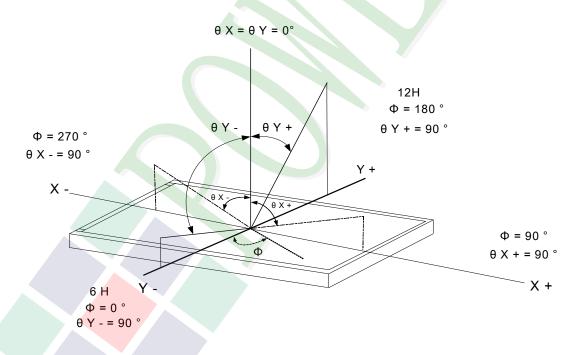
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note 4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics Maximum Ratings

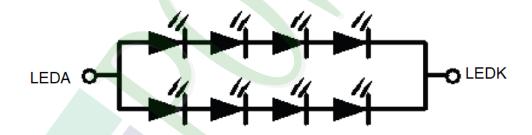
<u>ltem</u>	Symbol	Conditions	Min.	Max.	<u>Unit</u>
LED Forward Current	IF	Ta =25°ℂ	-	-	mA
LED Reverse Current	IR	Ta =25°ℂ	-	50	uA
Power Dissipation	PD	Ta =25°ℂ	-	1024	mW

Electrical / Optical Characteristics

<u>Item</u>	<u>Symbol</u>	Conditions	Min.	Typ.	Max.	<u>Unit</u>
Forward Voltage	VF	- IF=80mA	10.8	11.8	12.8	V
Uniformity *1	∆B	IF-60IIIA	75		-	*2
Color			Wł	nite		

*1: This value will be changed while mass production.

*2 : △B=B(min) / B(max)% B/L Internal Circuit Diagram



Other Description

<u>ltem</u>	<u>Conditions</u>	<u>Description</u>
Life Time	Ta =25°ℂ	20000 hrs
Life Pillie	IF=80mA	20000 1118



1.7 Touch Panel Characteristics

Features

<u>ltem</u>	Standard Value
Touch Panel Size	7"
Touch type	Projective capacitive touch panel
Input Method	True Multi-touch with up to 5 Points of Absolution X and Y Coordinates
Output Interface	I ² C
IC	FocalTechFT5426

I²C Address

Bit 7	Bit 6	<u>Bit 5</u>	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	1	1	1	0	0	0	R/W

Bit 0: 0 for Write / 1 for Read

Mechanical Specifications

<u>Item</u>	<u>Standard Value</u>	<u>Unit</u>
Viewing Area	Refer to drawing	mm

Absolute Maximum Ratings

<u>Item</u>	<u>Symbol</u>	<u>Condition</u>	<u>Min.</u>	Max.	<u>Unit</u>
Supply voltage	VDD	-	2.7	3.6	V
Operating Temperature	Тор	Non condenssing	-30	80	°C
Storage Temperature	T _{ST}	Non condenssing	-30	80	°C

DC Electrical Characteristics

<u>Item</u>	<u>Symbol</u>	Condition	Min.	<u>Тур.</u>	Max.	<u>Unit</u>
Supply voltage	VDD	-	-	3.3	-	V

Optical Characteristics

<u>Item</u>	<u>Standard Value</u>	<u>Unit</u>
Total light transmittance	85% or more	-
Hardness	≥6H	-



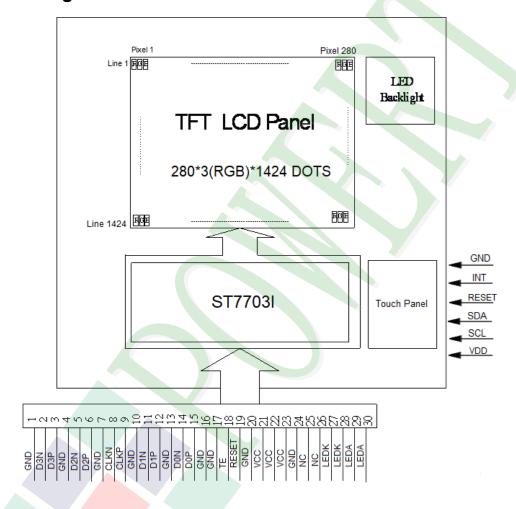
2. Module Structure

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

TFT LCM Interface CON1

Pin#	<u>Name</u>	<u>Description</u>		
1	GND	Ground		
2	D3N	Negative polarity of low voltage differential data signal		
3	D3P	Positive polarity of low voltage differential data signal		
4	GND	Ground		
5	D2N	Negative polarity of low voltage differential data signal		
6	D2P	Positive polarity of low voltage differential data signal		
7	GND	Ground		
8	CLKN	Negative polarity of low voltage differential clock signal		
9	CLKP	Positive polarity of low voltage differential clock signal		
10	GND	Ground		
11	D1N	Negative polarity of low voltage differential data signal		
12	D1P	Positive polarity of low voltage differential data signal		
13	GND	Ground		
14	D0N	Negative polarity of low voltage differential data signal		
15	D0P	Positive polarity of low voltage differential data signal		
16	GND	Ground		
17	GND	Ground		
18	TE	Tearing effect output pin to synchronize to frame writing. If not used, open this pin		
19	RESET	Reset signal pin		
20	GND	Ground		
21	VCC	Power supply		
22	VCC	Power supply		
23	VCC	Power supply		
24	GND	Ground		
25	NC	Not connect		
26	NC	Not connect		
27	VLED-	LED cathode		
28	VLED-	LED cathode		
29	VLED+	LED anode		
30	VLED+	LED anode		



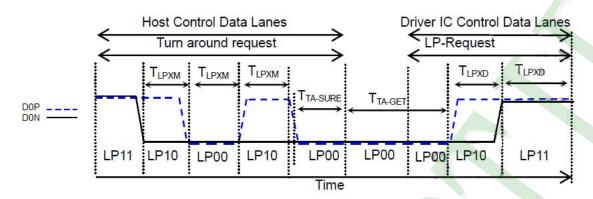
Capacitive Touch Panel (CTP) Interface CON2

Pin No.	<u>Symbol</u>	<u>Function</u>
1	GND	Touch Panel Ground.
2	INT	The interrupt the CTP to the Host
3	RESET	RESET Low
4	SDA	I2C Data
5	SCL	I2C Clock
6	VDD	Power Supply Voltage (3.3V)

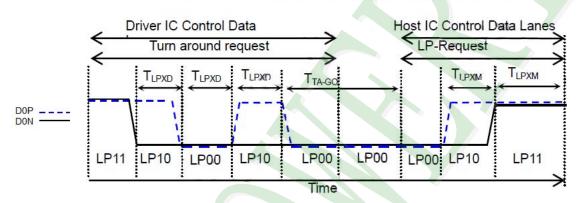


2.3 Timing Characteristics

2.3.1 Low Power Mode



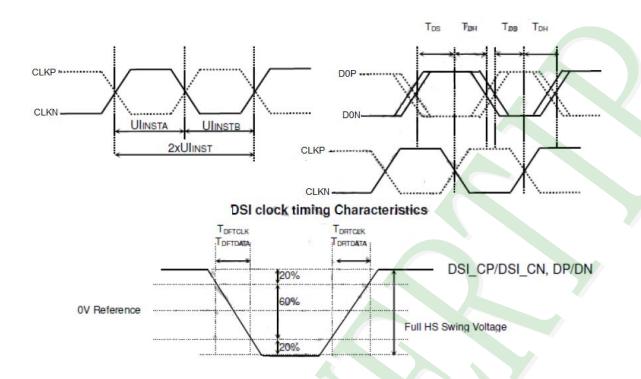
BTA from HOST to Display Module Timing



Cianal	ltom	Cymahal	>	Spec		Heit
<u>Signal</u>	<u>ltem</u>	<u>Symbol</u>	Min.	Typ.	Max.	<u>Unit</u>
	Length of LP-00/LP01/LP10/ LP11 Host→Display module	Тьрхм	50	-	-	ns
	Length of LP-00/LP01/LP10/ LP11Display module→Host	TLPXD	50	-	-	ns
D0P/ D0N	Time-out before the MPU start driver	Tta-sure	TLPXD	-	2xTLPXD	ns
	Time to drive LP-00 by display module	Tta-get	5xTlpxd	-	-	ns
	Time to drive LP-00 after turnaround request Host	Ттадо	4xTLPXD	-	-	ns



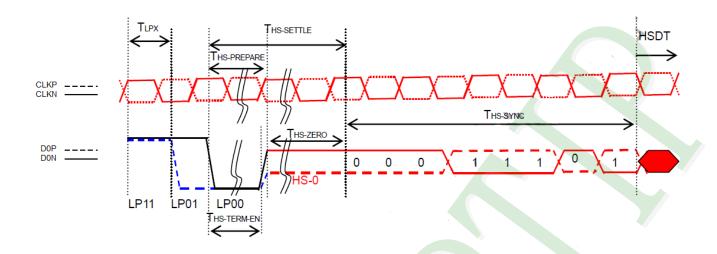
2.3.2 High Speed Mode



Ciamal	ltour	Complete		Heit		
<u>Signal</u> <u>Item</u>		<u>Symbol</u>	Min.	Typ.	Max.	<u>Unit</u>
CLKP /	Double UI instantaneous	2xUINST	TBD	-	25	ns
0.10.	UI instantaneous	UINSTA UINSTB	TBD	-	12.5	ns
D0P/	Data to clock setup time	TDS	0.15xUI	-	-	ps
D0N	Data to clock hold time	TDH	0.15xUI	-	-	ps
CLKP /	Differential rise time for clock	TDRTCLK	150	-	0.3UI	ps
CLKN	Differential fall time for clock	TDFTCLK	150	-	0.3UI	ps
DXP/	Differential rise time for data	TDRTDATA	150	-	0.3UI	ps
DXN	Differential fall time for data	TDFTDATA	150	-	0.3UI	ps



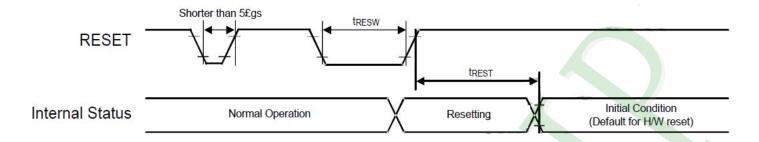
2.3.3 DSI BURSTS Mode



Cianal	Signal			Spec		110:4
<u>Signal</u>	<u>Item</u>	Symbol	Min.	Typ.	Max.	<u>Unit</u>
	Length of LP-00/LP01/LP10/ LP11	Тьрх	50		-	ns
	Time to Driver LP-00 toprepare for HS transmission	Ths-prepare	40+4UI	-	85+6UI	ns
D0P/ D0N	Time to enable data receiver line termination	Ths-term-en	-	-	35+4xUI	ns
	Time to drive LP-00 by display module	Tta-get	5xTlpxd	-	-	ns
	Time to drive LP-00 after turnaround request Host	Ttago	4xTLPXD	-	-	ns



2.3.4 Reset timing

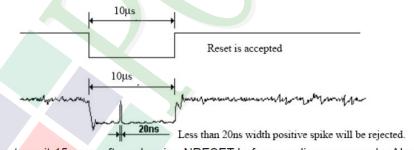


<u>Signal</u>	<u>Symbol</u>	<u>Parameter</u>	Min.	Max.	<u>Unit</u>
	tRESW	Reset low pulse width(1)	10	-	us
RESET	tREST Reset complete time(2)	15		ms	
	IKESI	Reset complete time(2)	120		ms

Note: (1) Spike due to an electrostatic discharge on NRESET line does not cause irregular system reset according to the following table.

NRESET Pulse	Action
Shorter than 5 µs	Reset Rejected
Longer than 10 µs	Reset
Between 5 µs and 10 µs	Reset Start

- (2) During the resetting period, the display will be blanked (The display is entering blanking sequence, which Maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode) and then return to Default condition for H/W reset.
- (3) During Reset Complete Time, ID and VCOM value in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 15ms after a rising edge of NRESET.
- (4) Spike Rejection also applies during a valid reset pulse as shown as below:

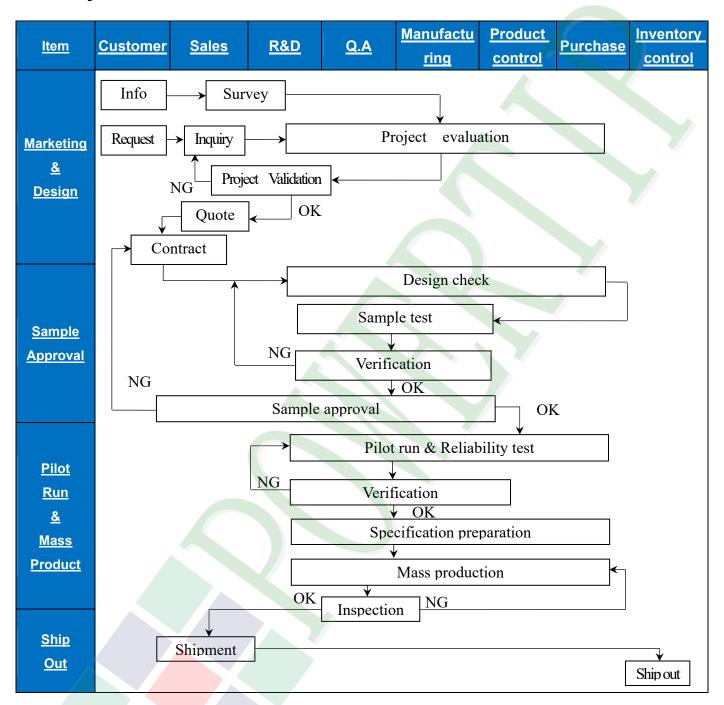


(5) It is necessary to wait 15msec after releasing NRESET before sending commands. Also Sleep Out command cannot be sent for 120msec.

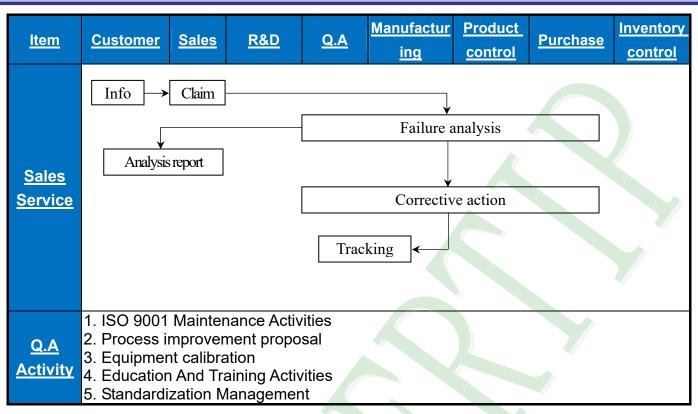


3. Quality Assurance System

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3.5"-15" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment: Gauge, MIL-STD, Powertip Tester, Sample

◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5

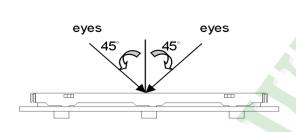
♦OUT Going Defect Level: Sampling

◆Standard of the product appearance test:

a. Manner of appearance test:

(1). The test best be under 20W×2 fluorescent light(about 300lux \sim 500lux) and distance of view must be at 30~40 cm.

(2). The test direction is base on about around 45° of vertical line.



5% Brightness

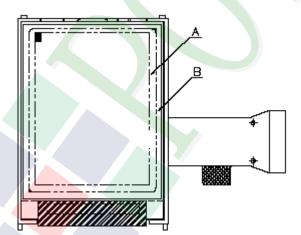
ND fliter

30~40 cm

LCD panel

2.5~3cm

(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



♦Specification For TFT-LCD Module 3.5"~15":

NO	<u>Item</u>	Criterion		
		1.1 The part number is inconsistent with work order of production.		
01	Product condition	1.2 Mixed product types.		
		1.3 Assembled in inverse direction.		
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major	
03	Outline dimension	3.1 Product dimension and structure must conform to structure diagram.	Major	
		4.1 Missing line character and icon.	Major	
	Electrical Testing	4.2 No function or no display.	Major	
		4.3 Display malfunction.		
04		4.4 LCD viewing angle defect.		
		4.5 Current consumption exceeds product specifications.		
		4.6 Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.		
05	Dot defect (Bright dot, Dark dot) On -display	Item Acceptance (O'tv) Bright Dot ≤ 4 Dot Defect Dark Dot ≤ 5 Joint Dot ≤ 3 Total ≤ 7 5.1 Inspection pattern: full white, full black, Red, Green and blue screens. 5.2 It is defined as dot defect if defect area > 1/2 dot. 5.3 The distance between two dot defect ≥5 mm. 5.4 Bright dot that can not be seen through 5% ND filter.		



◆Specification For TFT-LCD Module 3.5" ~15":

NO	<u>Item</u>				Level		
		6.1 Round type	(Non-display o				
				Aggont	ance (Q'ty)		
		Dimensio	on (diameter: Φ)	Accepta	B ar		
			Ф ≦ 0.25	Ignore			
	Black or white	0.25	$<$ Φ \leq 0.50	5	Igno	re	
	Dot, scratch,		Φ > 0.50	0	- Igno	16	
	contamination		Total	5			
	Round type	62 Line type(N	lon-display or di	snlav):			
	$\rightarrow X \leftarrow \downarrow$		ion diopidy of di	οριαγ).			
	Y	module size	Length	Width (W)	Acceptan A area	Ce (Q'ty) B area	
06	1		(L) 	W ≤ 0.03	Ignore	D area	Minor
	$\Phi = (x+y)/2$			$3 < W \leq 0.05$	4		
		3.5" to less	L ≦5.0 0.0	$5 < W \le 0.10$	2	4.	
		9"		W > 0.10	As round	Ignore	
	Line type				type		
	✓ W		То		5		
			L ≦10.0 0.0	$W \le 0.05$ $5 < W \le 0.10$	Ignore 5	_	
			L ≦10.0 0.0	3 < VV ≥ 0.10	As	-	
		9" to 15"		W > 0.10	round	Ignore	
			_		type	_	
			То	tal	5		
		Dimension	(diameters (A)	Accep	tance (Q't	(y)	
			<u>(diameter: Φ)</u>	A area	<u>B</u>	area	
07	Polarizer Bubble		Φ ≤ 0.25	Ignore			Minor
07			Φ ≤ 0.50	4			Minor
		0.50 <	$\Phi \leq 0.80$	1	lg	gnore	
		Т	Φ >0.80	0			
		I	otal	5			



◆Specification For TFT-LCD Module 3.5" ~15":

<u>NO</u>	<u>Item</u>	<u>Criterion</u>		
NO N	Item The crack of glass	Symbols: X: The length of crack Z: The thickness of crack T: The thickness of glass 8.1 General glass chip: 8.1.1 Chip on panel surface and crack between panels:	Level	
		Seal width X X Y Y Y Y Y Y		



◆Specification For TFT-LCD Module 3.5" ~15":

<u>NO</u>	<u> Item</u>	<u>Criterion</u> <u>Le</u>		
	X: The length of crack Z: The thickness of crack T: The thickness of glass 8.1.2 Corner crack:			
		<u>X</u> <u>Y</u> <u>Z</u>		
		≤1/5 a Crack can't enter viewing area Z ≤ 1/2 t		
		\leq 1/5 a Crack can't exceed the half of SP width. 1/2 t $<$ Z \leq 2 t		
08	The crack of glass		Minor	
00	The crack of glass	8.2 Protrusion over terminal:8.2.1 Chip on electrode pad:	IVIIIIOI	
		W.Y. X. W.Y. Z. W.Y. Z		
4		$\begin{array}{c cccc} X & \underline{Y} & \underline{Z} \\ \hline Front & \leq a & \leq 1/2 W & \leq t \\ \hline Back & \leq a & \leq W & \leq 1/2 t \\ \hline \end{array}$		



♦Specification For TFT-LCD Module 3.5″ ~15″:

<u>NO</u>	<u>Item</u>	<u>Criterion</u> <u>L</u>		
	Item The crack of glass		Level	



♦Specification For TFT-LCD Module 3.5"~15":

NO	<u> Item</u>	<u>Criterion</u>	
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
	General appearance	10.1 Pin type, quantity, dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC.	Major
40		10.3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major
10		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is $~\leq 1.5~\text{mm}.$	Minor



4. Reliability Test

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION		
1	High Temperature Storage Test	Keep in 80 ±5°C 240 hrs		
2	Low Temperature Storage Test	Keep in −30 ±5°C 240 hrs		
3	High Temperature / High Humidity Storage Test	Keep in 60 °C / 90% R.H duration for 240 hrs (Excluding the polarizer)		
4	Temperature Cycling Storage Test	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$		
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: 15°C ~35°C 2. Humidity relative: 30% ~60% 3. Energy Storage Capacitance(Cs+Cd): 150pF±10% 4. Discharge Resistance(Rd): 330 Ω±10% 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: ±5%)		
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration: 1.5 mm Each direction (X, Y, Z) duration for 2 hrs 		
7	Drop Test (Packaged)	Packing Weight (Kg) 0 ~ 45. 4 45. 4 ~ 90. 8 90. 8 ~ 454 Over 454 Drop Direction: **1 corner / 3 edge	122 76 61 46	

©Result Evaluation Criteria:

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function.

(Normal operation state) Temperature: +20~30°C

Humidity : 50~70%

Atmospheric pressure: 86~106Kpa



5. Precaution Relating Product Handling

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonic solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and $3 \sim 5$ sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.
- 5.2.10 Caution! (LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SPS) can lead to touch malfunction (e.g., ghost-touches). Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.
- 5.2.12 Double-sided tape designed to be attached with the customer's mechanical device, please follow up the rules and regulations published by the original manufacturer of double-side tape for the attachment operation.

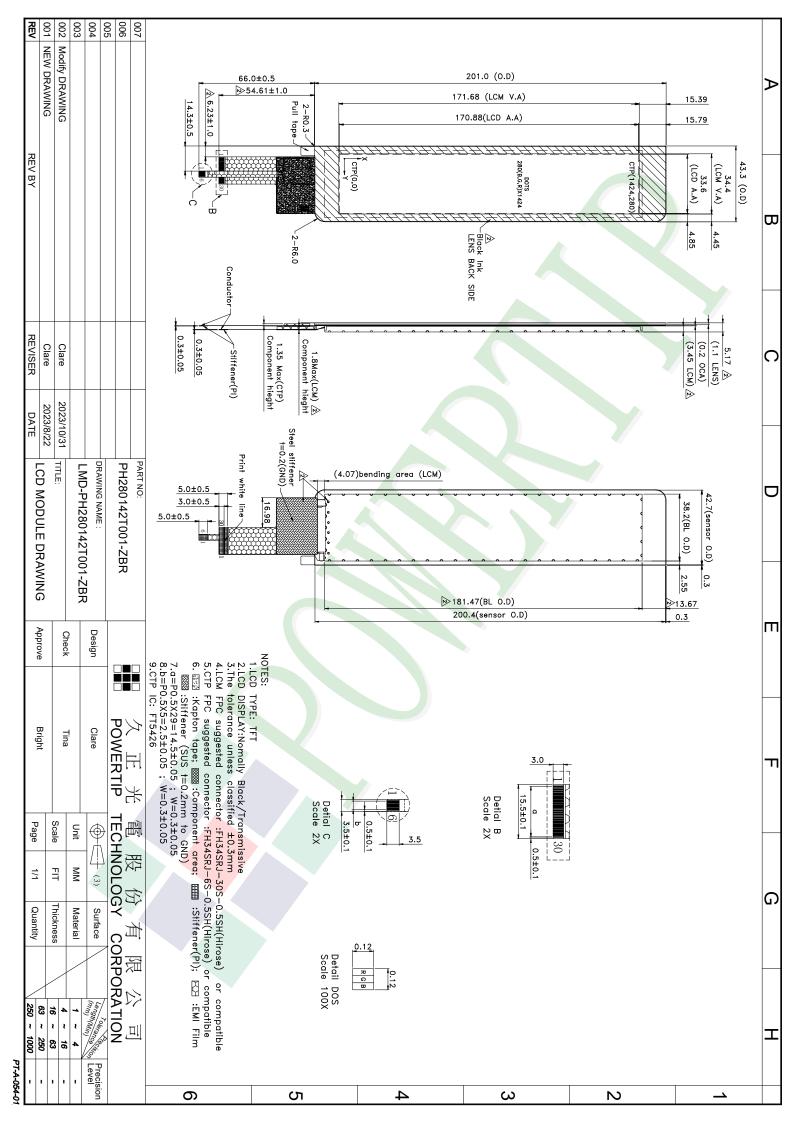
5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period

 The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

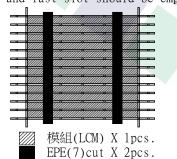


Approve Check Contact Ver.002 Packaging Specifications Clare Bright Tina Documents NO. PKG-PH280142T001-ZBR 1.包裝材料規格表(Packaging Material): (per carton) No. Item Mode 1 Dimensions (mm) 1Pcs Weight Quantity Total Weight 1 成品 (LCM) PH280142T001-ZBR 43.3 X 201.0 0.0771 96 7.4016 靜電袋(1)Antistatic Bag BAG350120ARABA 350 X 120 0.0042 96 0.4032 3 A2-1隔板(2)A2-1 Partition BX29500072BZBA 295 X 72 X 3.0 0.0109 104 1.1336 245 X 72 X 3.0 4 B2-1隔板(3)B2-1 Partition 0.0094 16 0.1504 BX24500072BZBA 5 氣泡紙(4)Bubble Sheet 280 X 240 0.006 16 0.096 BAG280240BWABA 6 C2内盒(5)Product Box 310 X 255 X 86 0.16 8 1.28 BX31025580AABA 7 外紙箱(6)Carton BX52732536CCBA 527 X 325 X 360 0.83 1 0.83 8 舒美墊(7)EPE OTFOAMEP0005BA 333 X 218 X 20 0.036 1 0.036 9 2. 一 整箱總重量 (Total LCD Weight in carton) : 11.33 Kg±10% 🖄 3.單箱數量規格表(Packaging Specifications and Quantity): (1)Quantity Of Spacer: A2-1 隔板 X 13 , B2-1 隔板 (2) Total LCM quantity in carton: quantity per box 12 x no of boxes 8 96 (4) 氣泡紙-Bubble Sheet (1)靜電袋+LCM Antistatic Bag+LCM (7)舒美墊 **EPE** (2)(3)隔板 Partition (註 Remark 1) (4) 氣泡紙 Bubble Sheet (6)外紙箱 Carton



- 1. LCM排放示意圖(前後間隔不放置):
- 1. LCM placed as figure showing: (First and last slot should be empty)

(5) C2內盒 Product Box



- 2.OTFOAMEP0005BA可裁 22 PCS:
- 尺寸:15.0 X 218.0 X 20.0 mm
- 2.OTFOAMEP0005BA cut 22 PCS:

Size:15.0 X 218.0 X 20.0 mm